

F7A16LCSP

A diagram of a microcontroller package, specifically a 16-pin Quad Flat Pack (QFP). The package is shown from a top-down perspective, with a central square area representing the silicon die. The pins are arranged in a square pattern around the die, with four pins on each side. The pins are labeled with numbers 1 through 16, starting from the top-left corner and proceeding clockwise. The package is colored red with yellow pins.

>VALUE